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Heatsinks for LEDs / **ICK LED R 23,5 x 14 G**   

Ø 23,5 x 14 mm, for IC design LED

Parameters of article ICK LED R 23,5 x 14 G

R_{th} [K/W]	 19.16
dissipation loss [W]	 6.3
mounting method	therm. conductive foil / therm. cond. adhesive
socket	universal
suitable for processor type	universal
Ø [mm]	 23.5
height [mm]	14
plate thickness [mm]	2.5
surface treatment	black anodised

[Technical Drawing](#)**Accessories/ related articles**Thermally conductive foil both sides adhesive / **WLFT 404 D 23**Thermally conductive foil both sides adhesive / **WLFT 405 D 23****Download CAD Drawing**

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